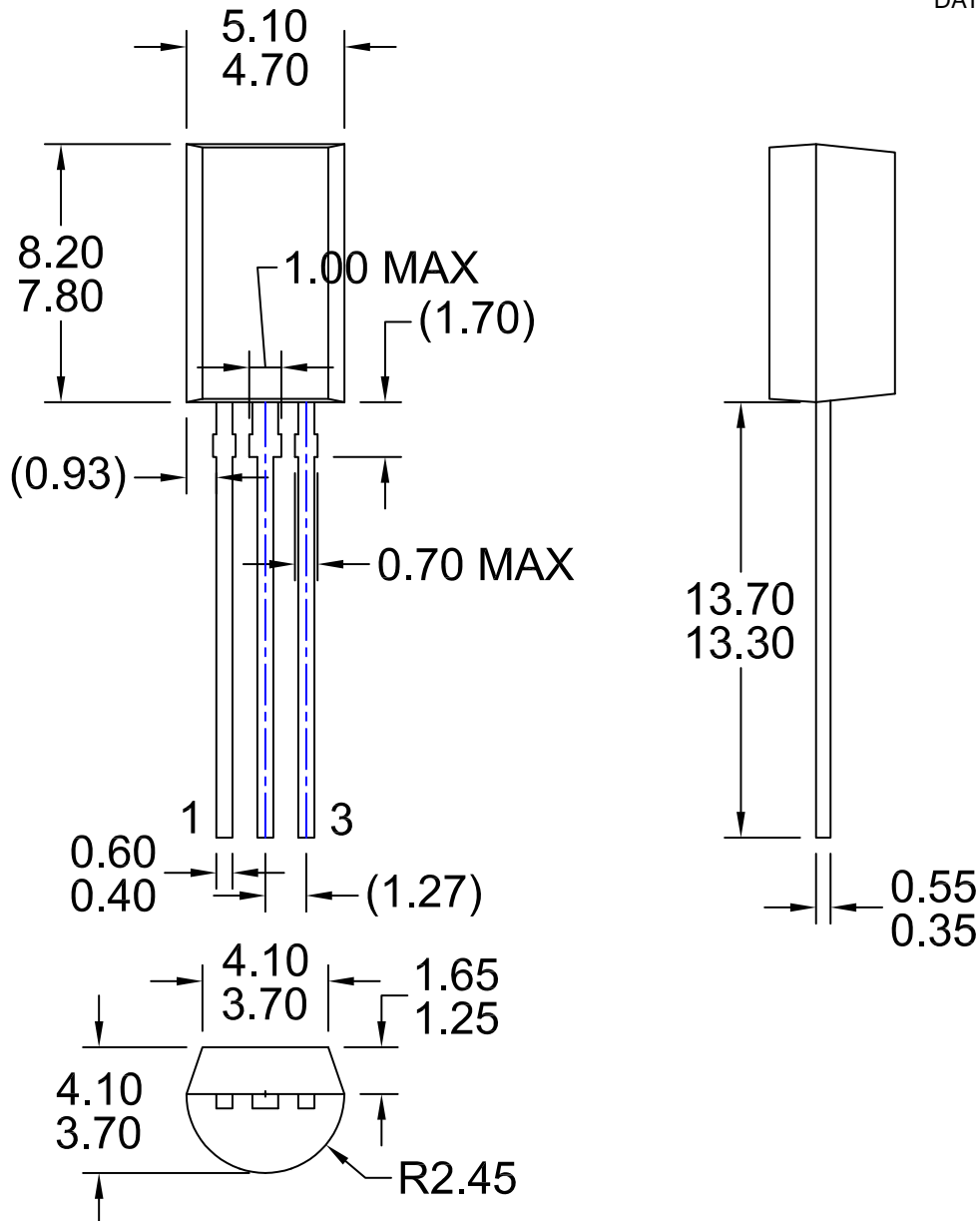


TO-92 3 8.0x4.9
CASE 135AP
ISSUE O

DATE 31 JUL 2016



- NOTES: UNLESS OTHERWISE SPECIFIED**
- A) THIS PACKAGE DOES NOT CONFORM TO ANY STANDARD
 - B) ALL DIMENSIONS ARE IN MILLIMETERS.
 - C) DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.

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